

## CMOS Logic

### ■ GENERAL DESCRIPTION

XC74WL34AASR is triple buffer manufactured using silicon gate CMOS processes. The small supply current, which is one of the features of the CMOS logic, gives way to high speed operations which enables LS-TTL. With wave forming buffers connected internally, stabilized output can be achieved as the series offers high noise immunity. As the series is integrated into a mini molded, MSOP-8B package, high density mounting is possible.

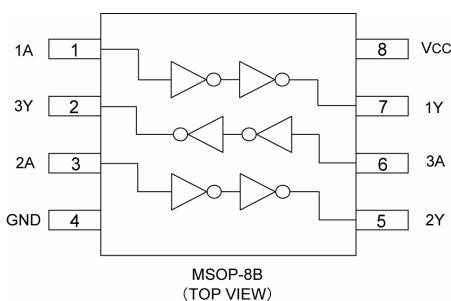
### ■ APPLICATIONS

- Palmtops
- Digital equipment

### ■ FEATURES

- High Speed Operations** : tpd = 2.05ns (TYP.) (VCC=5V)
- Operating Voltage Range** : 2V ~ 5.5V
- Low Power Consumption** : 1 μ A (MAX.)@Ta=25°C
- CMOS Logic Triple Buffer**
- Small Package** : MSOP-8B

### ■ PIN CONFIGURATION



### ■ FUNCTIONS

INPUT	OUTPUT
A	Y
H	H
L	L

H=High level

L=Low level

### ■ ABSOLUTE MAXIMUM RATINGS

Ta=-40°C~85°C

PARAMETER	SYMBOL	RATINGS	UNITS
Power Supply Voltage	VCC	-0.5~+6.0	V
Input Voltage	VIN	-0.5~+6.0	V
Output Voltage	VOUT	-0.5~Vcc+0.5	V
Input Diode Current	IIK	-20	mA
Output Diode Current	IOK	±20	mA
Switch Output Current	IOUT	±25	mA
Vcc,GND Current	Icc,IGND	±50	mA
Power Dissipation (Ta = 25°C)	Pd	300	mW
Storage Temperature Range	Tstg	-65~+150	°C

Note : Voltage is all ground standardized.

## ■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL	CONDITIONS	UNITS
Supply Voltage	Vcc	2~5.5	V
Input Voltage	V <sub>IN</sub>	0~5.5	V
Output Voltage	V <sub>OUT</sub>	0~VCC	V
Operating Temperature Range	T <sub>opr</sub>	-40~+85	°C
Input Rise and Fall Time	tr,tf	0~200 (Vcc=3.3V) 0~100 (Vcc=5V)	ns

## ■ DC ELECTRICAL CHARACTERISTICS

PARAMETER	SYMBOL	CONDITIONS			Ta=25°C		Ta=-40°C~85°C		UNITS		
					MIN.	TYP.	MAX.	MIN.			
Input Voltage	V <sub>IH</sub>	2.0				1.5	—	—	1.5	V	
		3.0				2.1	—	—	2.1		
		5.5				3.85	—	—	3.85		
	V <sub>IL</sub>	2.0				—	—	0.5	—	V	
		3.0				—	—	0.9	—		
		5.5				—	—	1.65	—		
Output Voltage	V <sub>OH</sub>	2.0	V <sub>IN</sub> =V <sub>IH</sub>	I <sub>OH</sub> =-50 μA	1.9	2.0	—	1.9	—	V	
		3.0			2.9	3.0	—	2.9	—		
		4.5			4.4	4.5	—	4.4	—		
		3.0			I <sub>OH</sub> =-4mA	2.58	—	2.48	—		
		4.5			I <sub>OH</sub> =-8mA	3.94	—	3.80	—		
	V <sub>OL</sub>	2.0	V <sub>IN</sub> =V <sub>IL</sub>	I <sub>OL</sub> =50 μA	—	—	0.1	—	0.1	V	
		3.0			—	—	0.1	—	0.1		
		4.5			—	—	0.1	—	0.1		
		3.0			I <sub>OL</sub> =4mA	—	—	0.36	—		
		4.5			I <sub>OL</sub> =8mA	—	—	0.36	—		
Input Voltage	I <sub>IN</sub>	0~5.5	V <sub>IN</sub> =Vcc or GND		-0.1	—	0.1	-1.0	1.0	μA	
Static Supply Current	I <sub>cc</sub>	5.5	V <sub>IN</sub> =Vcc or GND, I <sub>OUT</sub> =0 μA		—	—	1.0	—	10.0	μA	

## ■ SWITCHING ELECTRICAL CHARACTERISTICS

(tr=tf=3ns)

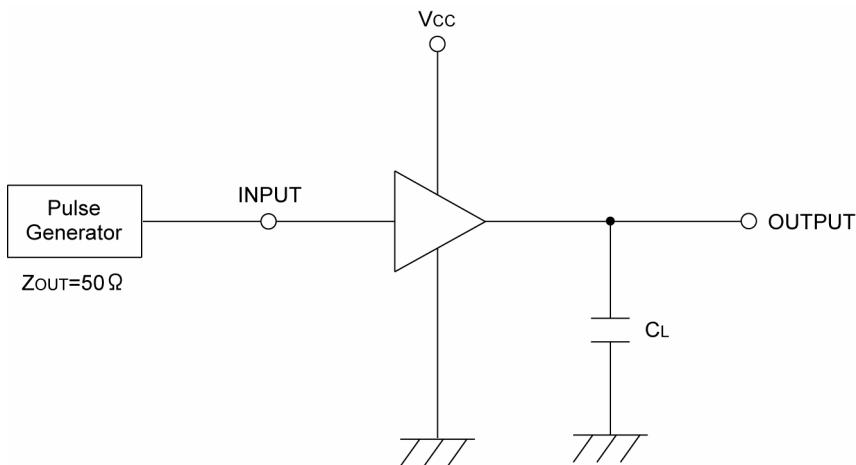
PARAMETER	SYMBOL	CONDITIONS			Ta=25°C		Ta=-40°C~85°C		UNITS	
					MIN.	TYP.	MAX.	MIN.		
Delay Time	t <sub>PLH</sub>	15pF	3.3		—	2.7	7.1	1.0	8.5	ns
			5.0		—	2.1	5.5	1.0	6.5	
	t <sub>PHL</sub>	50pF	3.3		—	4.1	10.6	1.0	12	ns
			5.0		—	3.2	7.5	1.0	8.5	
	t <sub>PLH</sub>	15pF	3.3		—	2.5	7.1	1.0	8.5	ns
			5.0		—	2.0	5.5	1.0	6.5	
Input Capacitance	t <sub>PHL</sub>	50pF	3.3		—	3.9	10.6	1.0	12	ns
			5.0		—	3.0	7.5	1.0	8.5	
	C <sub>IN</sub>	—	5.0	V <sub>IN</sub> =Vcc or GND		—	2	10	—	10 pF
Power Dissipation Capacitance	C <sub>pd</sub>	No Load, f=1MHz			—	8.9	—	—	—	pF

## ■NOISE CHARACTERISTICS

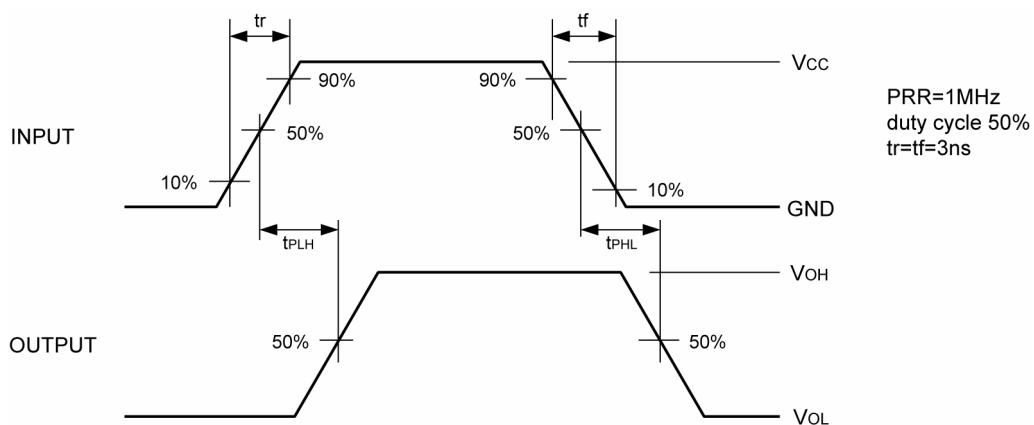
(tr=tf=3ns)

PARAMETER	SYMBOL			CONDITIONS	Ta=25°C			UNITS
		CL	Vcc(V)		MIN.	TYP.	MAX.	
Non Functional Output Maximum Dynamic VOL	VOLP	50pF	5.0		—	0.3	0.8	V
Non Functional Output Minimum Dynamic VOL	VOLV	50pF	5.0		- 0.8	- 0.3	—	V
Minimum Dynamic VIH	VIHD	50pF	5.0		—	—	3.5	V
Maximum Dynamic VIL	VILD	50pF	5.0		—	—	1.5	V

## ■TEST CIRCUIT



## ■WAVEFORM



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